

**Amendments to the Specification:**

Please replace paragraph [0046] with the following amended paragraph:

[0046] A "thermoplastic adhesive" is understood according to embodiments of the present invention to be a material that has no adhesive properties below a given temperature. Above a given temperature, in one aspect above the melting point of the material, the material shows sticky properties or adhesive properties, whereby these properties also remain in the solidified state after binding two substrates in the molten state. The respective sticky or adhesive properties can appear at least about 10°C. in one aspect, in another aspect at least about 20°C, and in yet another aspect within a range of about 21°C. to about 100°C. above the melting point, determined by differential scanning calometry (DSC), of the material or material mixture used as thermoplastic adhesive. It is also possible in the present invention to use thermoplastic adhesives that comprise two [[ore]] or more different compounds. The two [[ore]] or more compounds can differ from each other in the chemical composition or in their molecular weight or in both.